

PCN Number:	20160928000	PCN Date:	Oct. 6, 2016
Title:	Datasheet for OPA373, OPA374, OPA2373, OPA2374, OPA4374		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification etc.

The product datasheet(s) is being updated as summarized below.

The following change history provides further details.



OPA373, OPA374
OPA2373, OPA2374, OPA4374

SBOS279F – SEPTEMBER 2003 – REVISED SEPTEMBER 2016

Changes from Revision E (May 2008) to Revision F

Page

- Added ESD Rating table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section 1
- Deleted Package/Ordering Information table; refer to Package Option Addendum at the end of this data sheet 4
- Deleted lead temperature specification from Absolute Maximum Ratings 7
- Changed values in the Thermal Information tables to align with JEDEC standards 7

The datasheet number will be changing.

Device Family	Change From:	Change To:
OPAx373, OPAx374	SBOS279E	SBOS279F

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/OPA373>

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:			
OPA2373AIDGSR	OPA2374AIDG4	OPA373AIDR	OPA374AIDRG4
OPA2373AIDGST	OPA2374AIDR	OPA373AIDRG4	OPA4374AID
OPA2373AIDRCR	OPA2374AIDRG4	OPA374AID	OPA4374AIDG4
OPA2373AIDRCRG4	OPA373AID	OPA374AIDBVR	OPA4374AIDR
OPA2373AIDRCT	OPA373AIDBVR	OPA374AIDBVRG4	OPA4374AIDRG4
OPA2374AID	OPA373AIDBVRG4	OPA374AIDBVT	OPA4374AIPWR
OPA2374AIDCNR	OPA373AIDBVT	OPA374AIDBVTG4	OPA4374AIPWRG4
OPA2374AIDCNRG4	OPA373AIDBVTG4	OPA374AIDG4	OPA4374AIPWT
OPA2374AIDCNT	OPA373AIDG4	OPA374AIDR	OPA4374AIPWTG4
OPA2374AIDCNTG4			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com